

# 40× CD-ROM Decoder with SCSI Interface

## **Functions**

- CD-ROM ECC function
- SCSI I/F function
- Subcode I/F function
- CAV audio function

## **Features**

- SCSI interface (includes on-chip SCAM selection register)
- Supports 20× speed and a 10 MBytes/s transfer rate when using 16-bit 70-ns EDO DRAM
- Supports 40× speed and a 10 MB/s transfer rate when using 16-bit 50-ns EDO DRAM
- Up to 4 M bits of buffer RAM can be used.
- The user can freely set up the CD main channel and the C2 flag areas in buffer RAM.
- Batch transfer function (Allows the CD main channel, the C2 flags, and other data to be sent in a single operation.)
- Multi-block transfer function (Allows multiple blocks to be sent automatically in a single operation.)
- Subcode buffering and CD-TEXT support

## **Specifications**

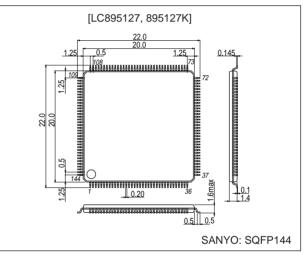
#### Absolute Maximum Ratings at $V_{SS} = 0$ V

- CAV audio function
- Supports 20 MBytes/s transfers
- Package: SQFP-144

## **Package Dimensions**

unit: mm

## 3214-SQFP144



| Parameter                             | Symbol              | Conditions | Ratings                       | Unit |
|---------------------------------------|---------------------|------------|-------------------------------|------|
| Maximum supply voltage                | V <sub>DD</sub> max | Ta = 25°C  | -0.3 to +7.0                  | V    |
| Input/output voltage                  | VI, VO              | Ta = 25°C  | -0.3 to V <sub>DD</sub> + 0.3 | V    |
| Allowable power dissipation           | Pd max              | Ta ≤ 70°C  | 550                           | mW   |
| Operating temperature                 | Topr                |            | -30 to +70                    | °C   |
| Storage temperature                   | Tstg                |            | -55 to +125                   | °C   |
| Soldering temperature (pin part only) |                     | 10 s       | 260                           | °C   |

#### Allowable Operating Ranges at Ta = $-30^{\circ}$ C to $+70^{\circ}$ C, V<sub>SS</sub> = 0 V

| Parameter           | Symbol Conditions |            | Ratings |     |                 | Unit |
|---------------------|-------------------|------------|---------|-----|-----------------|------|
| Falameter           | Symbol            | Conditions | min     | typ | max             | Unit |
| Supply voltage      | V <sub>DD</sub>   |            | 4.5     | 5.0 | 5.5             | V    |
| Input voltage range | V <sub>IN</sub>   |            | 0       |     | V <sub>DD</sub> | V    |

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| Parameter                 | Cumbol           | Conditions                | Appliaghle pize |                       | Ratings |                     | Unit |
|---------------------------|------------------|---------------------------|-----------------|-----------------------|---------|---------------------|------|
| Parameter                 | Symbol           | Conditions                | Applicable pins | min                   | typ     | max                 | Unit |
| Input high-level voltage  | V <sub>IH1</sub> | TTL levels                | (4)             | 2.2                   |         |                     | V    |
| Input low-level voltage   | V <sub>IL1</sub> |                           | (1)             |                       |         | 0.8                 | V    |
| Input high-level voltage  | V <sub>IH2</sub> | TTL levels                | (0)             | 2.2                   | _       | _                   | V    |
| Input low-level voltage   | V <sub>IL2</sub> | with pull-up resistor     | (9)             | —                     | _       | 0.8                 | V    |
| Input high-level voltage  | V <sub>IH3</sub> | TTL levels                | (2)             | 2.2                   | _       | _                   | V    |
| Input low-level voltage   | V <sub>IL3</sub> | Schmitt                   | (2)             | —                     | _       | 0.8                 | V    |
| Input high-level voltage  | V <sub>IH4</sub> | CMOS levels               | (2)             | 0.8 V <sub>DD</sub>   | _       | _                   | V    |
| Input low-level voltage   | V <sub>IL4</sub> | Schmitt                   | (3)             | —                     | _       | 0.2 V <sub>DD</sub> | V    |
| Input high-level voltage  | V <sub>IH5</sub> |                           | (4) (0) (10)    | 2.0                   |         | _                   | V    |
| Input low-level voltage   | V <sub>IL5</sub> |                           | (4), (8), (10)  |                       |         | 0.8                 | V    |
| Input high-level voltage  | V <sub>IH2</sub> | TTL levels                | (11)            | 2.2                   |         | _                   | V    |
| Input low-level voltage   | V <sub>IL2</sub> | with pull-up resistor     | (11)            | —                     | _       | 0.8                 | V    |
| Output high-level voltage | V <sub>OH1</sub> | I <sub>OH1</sub> = -12 mA | (6)             | V <sub>DD</sub> – 2.1 | _       | _                   | V    |
| Output low-level voltage  | V <sub>OL1</sub> | I <sub>OL1</sub> = 12 mA  | (6)             | —                     | _       | 0.4                 | V    |
| Output high-level voltage | V <sub>OH2</sub> | I <sub>OH2</sub> = -8 mA  | (7)             | 2.4                   |         |                     | V    |
| Output low-level voltage  | V <sub>OL2</sub> | I <sub>OL2</sub> = 8 mA   | (7)             |                       |         | 0.4                 | V    |
| Output high-level voltage | V <sub>OH2</sub> | I <sub>OH2</sub> = -2 mA  | (0) (5) (11)    | 2.4                   |         |                     | V    |
| Output low-level voltage  | V <sub>OL2</sub> | I <sub>OL2</sub> = 2 mA   | (9), (5), (11)  |                       |         | 0.4                 | V    |
| Output low-level voltage  | V <sub>OL4</sub> | I <sub>OL4</sub> = 48 mA  | (10)            |                       |         | 0.4                 | V    |
| Input leakage current     | IIL              | $V_{I} = V_{SS}, V_{DD}$  | All input pins  | -25                   |         | +25                 | μA   |
| Pull-up resistance        | R <sub>UP</sub>  |                           | (5), (9), (11)  | 60                    | 120     | 240                 | kΩ   |

## DC Characteristics at Ta = -30 to +70 $^{\circ}C,$ $V_{SS}$ = 0 V, $V_{DD}$ = 4.5 to 5.5 V

Applicable pin sets are as follows.

INPUT

(1) TEST0 to TEST4, CSCTRL, SUA0 to SUA6, C2P0, SDATA, BCK, LRCK, SCOR, WFCK, SBS0, MCK2SEL

(2) RESET

(3)  $\overline{\text{CS}}, \overline{\text{RD}}, \overline{\text{WR}}$ 

(4) SCSISEL, XTALSEL

OUTPUT

(5)  $\overline{INT0}$ ,  $\overline{INT1}$ ,  $\overline{SWAIT}$ 

(6) MCK

(7) EXCK, DSDATA, DLRCK, DBCK, RASO, CASO, CASO, OE, UWE, LWE, RAO to RA8

INOUT

(8) ACK, ATN

- (9) D0 to D7, IO0 to IO15, IOP0 to IOP7
- (10)  $\overline{DB0}$  to  $\overline{DB7}$ ,  $\overline{DBP}$ ,  $\overline{BSY}$ , I/O,  $\overline{MSG}$ ,  $\overline{SEL}$ ,  $\overline{RST}$ ,  $\overline{REQ}$ , C/D

(11) IOP0 to IOP7

Note: Pins XTAL0, XTALCK0, XTAL1, XTALCK1, and X1EN are not included in DC characteristics.

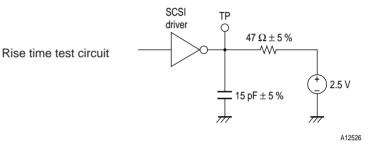
#### **SCSI Pin Input Characteristics**

| Parameter               | Symbol            | Conditions                       | Ratings |      |      | Unit |
|-------------------------|-------------------|----------------------------------|---------|------|------|------|
| Falameter               | Symbol            |                                  | min     | typ  | max  | Unit |
| Input threshold voltage | V <sub>t+t1</sub> |                                  |         | 1.60 | 2.00 | V    |
| input theshold voltage  | V <sub>t-t1</sub> | V <sub>DD</sub> = 4.50 to 5.50 V | 0.80    | 1.10 |      | V    |
| Hysteresis width        | $\Delta V_{tt1}$  | V <sub>DD</sub> = 5.0 V          | 0.41    | 0.5  |      | V    |

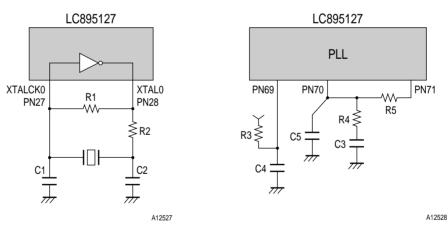
#### **Active-Low Output Characteristics**

| Parameter                 | er Symbol       | Conditions | Ratings |     |     | Unit |
|---------------------------|-----------------|------------|---------|-----|-----|------|
| Falanetei                 | Symbol          | Conditions | min     | typ | max | Unit |
| Output high-level voltage | V <sub>OH</sub> |            | 2.5     |     |     | V    |
| Output low-level voltage  | V <sub>OL</sub> |            |         |     | 0.4 | V    |

Note: Only applies to the active-low output pins DB0 to DB7, REQ, DBPB



## **Recommended Oscillator and PLL Circuits**



 $R1 = 120 \text{ k}\Omega$ ,  $R2 = 47 \Omega$ , C1 = 30 pF

Crystal oscillator frequency XTALCK0 = 16.9344 MHz

 $R3 = 7.5 \text{ k}\Omega, R4 = 200 \Omega, R5 = 10 \text{ k}\Omega, C3 = 0.1 \mu\text{F}$ 

 $C4 = 0.1 \ \mu F, C5 = 0.002 \ \mu F$  to 0.01  $\mu F$ 

Note: The values listed above for R3, R4, R5, and C3 also apply when the XTALKC0 frequency is 33.8688 MHz.

Applications must be designed so that the analog  $V_{DD}$  and  $V_{SS}$  power supply system is completely independent of the logic system power supply and is not affected by the logic system power supply fluctuation in any way.

Note: Since the exact values of these components will vary depending on the characteristics of the printed circuit board used and other factors, consult the manufacturer of the crystal element when designing the oscillator circuit.

## **Pin Functions**

|   |        |   | Туре        |    |             |
|---|--------|---|-------------|----|-------------|
| I | INPUT  | В | BIDIRECTION | NC | NOT CONNECT |
| 0 | OUTPUT | Р | POWER       |    |             |

| Pin No.  | Pin name                            | Туре    | Pin functions   |  |
|----------|-------------------------------------|---------|---|--|
| 1        | V <sub>SS0</sub>                    | Р       |   |  |
| 2        | 102                                 | В       |   |  |
| 3        | IO1                                 | В       | Buffer RAM data I/O   |  |
| 4        | 100                                 | В       | These pins have built-in pull-up resistors.   |  |
| 5        | MCK2SEL                             | 1       | PLL frequency selection. Currently, this pin must be connected to V <sub>DD</sub> . |  |
| 6        | C2PO                                | 1       |   |  |
| 7        | SDATA                               | 1       |   |  |
| 8        | BCK                                 | 1       | CD DSP interface  |  |
| 9        | LRCK                                | 1       | -   |  |
| 10       | EXCK                                | 0       | Subcode I/O   |  |
| 11       | WFCK                                | 1       |   |  |
| 12       | SBSO                                | 1       |   |  |
| 13       | SCOR                                | 1       | Subcode I/O   |  |
| 14       | DSDATA                              | 0       |   |  |
| 15       | DLRCK                               | 0       | _<br>D/A converter outputs  |  |
| 16       | DBCK                                | 0       |   |  |
| 17       | MCK                                 | 0       | XTALCLK0 1/1, 1/2, and stop output  |  |
| 18       | V <sub>DD</sub>                     | P       |   |  |
| 19       | V <sub>DD</sub><br>V <sub>SS0</sub> | P       |   |  |
| 20       | RESET                               | - '<br> | IC reset. The IC is reset on a low-level input                                      |  |
| 20       | CSCTRL                              |         | MC (Microcontroller) CSL <sub>0</sub> , Hi  |  |
| 21       | TEST3                               |         |   |  |
| 22       | TESTO                               |         | -   |  |
|          | TEST1                               |         | Test pins. These pins must be connected to V <sub>SS0</sub> in normal operation.    |  |
| 24       |                                     |         |   |  |
| 25       | TEST2                               |         |   |  |
| 26       | V <sub>SS0</sub>                    | P       |   |  |
| 27       | XTALCK0                             | 1       | Crystal oscillator circuit input  |  |
| 28       | XTAL0                               | 0       | Crystal oscillator circuit output   |  |
| 29       | TEST4                               |         | Test pin. This pin must be connected to V <sub>SS0</sub> in normal operation.       |  |
| 30       | V <sub>SS0</sub>                    | P       |   |  |
| 31       | V <sub>SS0</sub>                    | P       |   |  |
| 32       | V <sub>SS0</sub>                    | P       |   |  |
| 33       | V <sub>SS0</sub>                    | P .     |   |  |
| 34       | IOP7                                |         | General-purpose I/O ports. These pins include built-in pull-up resistors.           |  |
| 35       | IOP6                                |         |   |  |
| 36       | V <sub>SS0</sub>                    | P       |   |  |
| 37       | V <sub>DD</sub>                     | P       |   |  |
| 38       | IOP5                                | 1       | -   |  |
| 39       | IOP4                                | 1       | -   |  |
| 40       | IOP3                                | 1       | General-purpose I/O ports. These pins include built-in pull-up resistors.           |  |
| 41       | IOP2                                | 1       |   |  |
| 42       | IOP1                                | 1       | -   |  |
| 43       | IOP0                                | I       |   |  |
| 44       | V <sub>SS0</sub>                    | Р       |   |  |
| 45       | RD                                  | 1       | Microcontroller data read signal input  |  |
| 46       | WR                                  | 1       | Microcontroller data write signal input   |  |
| 47       | CS                                  | 1       | Register chip select input from the microcontroller                                 |  |
| 48       | SUA0                                | 1       |   |  |
| 49       | SUA1                                | 1       |   |  |
| 50       | SUA2                                | I       | Microcontroller register selection signals  |  |
| 51       | SUA3                                | 1       |   |  |
|          |                                     | 1 .     |   |  |
| 52<br>53 | SUA4<br>SUA5                        |         | -   |  |

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| Pin No.    | Pin              | I/O | Function   |
|------------|------------------|-----|--|
| 54         | V <sub>DD</sub>  | Р   |  |
| 55         | V <sub>SS0</sub> | Р   |  |
| 56         | SUA6             | I   | Microcontroller register selection signals   |
| 57         | D0               | В   |  |
| 58         | D1               | В   |  |
| 59         | D2               | В   |  |
| 60         | D3               | В   | Microcontroller data signals   |
| 61         | D4               | В   |  |
| 62         | D5               | В   |  |
| 63         | V <sub>SS0</sub> | Р   |  |
| 64         | D6               | В   | Missessettelles dete simple  |
| 65         | D7               | В   | Microcontroller data signals   |
| 66         | <b>INTO</b>      | 0   | Interrupt request signal output to the microcontroller (ECC side. Set by setting a register value.)  |
| 67         | INT1             | 0   | Interrupt request signal output to the microcontroller (SCSI side. Set by setting a register value.) |
| 68         | SWAIT            | 0   | Wait signal output to the microcontroller  |
| 69         | X1EN             | I   | Used by the PLL. This pin must be connected to V <sub>DD</sub> through a resistor.                   |
| 70         | XTALCK1          | I   | Used by the PLL.   |
| 71         | XTAL1            | 0   | Used by the PLL.   |
| 72         | V <sub>SS0</sub> | Р   | Analog V <sub>SS</sub>   |
| 73         | V <sub>DD</sub>  | P   | Analog V <sub>DD</sub>   |
| 74         |                  | NC  |  |
| 75         | I/O              | В   |  |
| 76         | REQ              | В   | - SCSI interface   |
| 77         | V <sub>SS1</sub> | Р   |  |
| 78         | C/D              | В   |  |
| 79         | SEL              | В   | SCSI interface   |
| 80         |                  | NC  |  |
| 81         | V <sub>DD</sub>  | Р   |  |
| 82         | V <sub>SS1</sub> | Р   |  |
| 83         | MSG              | В   |  |
| 84         | RST              | В   | SCSI interface   |
| 85         | V <sub>SS1</sub> | P   |  |
| 86         | ACK              | В   |  |
| 87         | BSY              | B   | SCSI interface   |
| 88         | V <sub>SS1</sub> | В   |  |
| 89         | ATN              | B   | SCSI interface   |
| 90         | V <sub>DD</sub>  | P   |  |
| 91         | V <sub>SS1</sub> | P   |  |
| 92         | • 331            | NC  |  |
| 93         | DBP              | В   | SCSI interface   |
| 94         | V <sub>DD</sub>  | P   |  |
| 95         | DB7              | B   |  |
| 96         | DB6              | B   | SCSI interface   |
| 97         | V <sub>SS1</sub> | P   |  |
| 98         | DB5              | В   |  |
| 99         | DB3<br>DB4       | В   | SCSI interface   |
| 100        | V <sub>DD</sub>  | P   |  |
| 101        | DB3              | В   |  |
| 102        | DB3              | B   | SCSI interface   |
| 102        | V <sub>SS1</sub> | P   |  |
| 103        |                  | В   |  |
| 10-1       |                  |     | SCSI interface   |
|            | DRO              | I R |  |
| 105<br>106 | DB0<br>SCSISEL   | B   | SCSI pin layout selection. (This pin must be connected to V <sub>SS0</sub> .)                        |

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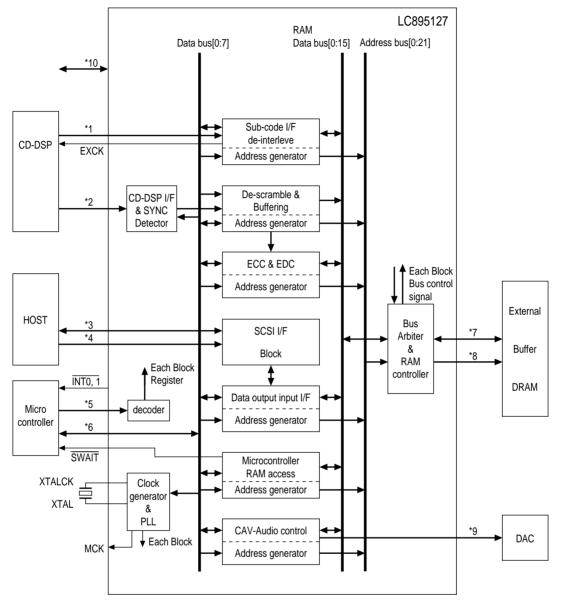
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| Pin No. | Pin              | I/O | Function  |
|---------|------------------|-----|---|
| 108     | V <sub>SS1</sub> | Р   |   |
| 109     | V <sub>DD</sub>  | Р   |   |
| 110     | V <sub>SS0</sub> | Р   |   |
| 111     | RAS0             | 0   | Buffer RAM RAS signal output 0                                    |
| 112     | V <sub>DD</sub>  | Р   |   |
| 113     | CAS0             | 0   | Buffer RAM CAS signal output 0 (Normally held fixed at 0 (low).)  |
| 114     | CAS1             | 0   | Buffer RAM RAS signal output 1                                    |
| 115     | ŌĒ               | 0   | Buffer RAM output enable  |
| 116     | UWE (RA9)        | 0   | Buffer RAM upper write enable (RA9 when 8M or more DRAM is used.) |
| 117     | LWE              | 0   | Buffer RAM lower write enable                                     |
| 118     | V <sub>SS0</sub> | Р   |   |
| 119     | RA0              | 0   |   |
| 120     | RA1              | 0   |   |
| 121     | RA2              | 0   |   |
| 122     | RA3              | 0   | Buffer RAM address signal outputs                                 |
| 123     | RA4              | 0   |   |
| 124     | RA5              | 0   |   |
| 125     | RA6              | 0   |   |
| 126     | V <sub>DD</sub>  | Р   |   |
| 127     | V <sub>SS0</sub> | Р   |   |
| 128     | RA7              | 0   | Duffer DAM eddroes simple utsuts                                  |
| 129     | RA8              | 0   | Buffer RAM address signal outputs                                 |
| 130     | IO15             | В   |   |
| 131     | IO14             | В   |   |
| 132     | IO13             | В   |   |
| 133     | IO12             | В   | Buffer RAM data I/O   |
| 134     | IO11             | В   | These pins have built-in pull-up resistors.                       |
| 135     | IO10             | В   |   |
| 136     | IO9              | В   | ]   |
| 137     | IO8              | В   |   |
| 138     | V <sub>SS0</sub> | Р   |   |
| 139     | 107              | В   |   |
| 140     | IO6              | В   |   |
| 141     | IO5              | В   | Buffer RAM data I/O   |
| 142     | IO4              | В   | These pins have built-in pull-up resistors.                       |
| 143     | IO3              | В   |   |
| 144     | V <sub>DD</sub>  | Р   |   |

Unused ("NC") pins must be left open. Pins whose name is under a bar operate with inverted (negative) logic.  $V_{SS0}$  is the logic system ground and  $V_{SS1}$  is the SCSI interface driver ground. If DRAM is used, applications must adopt measures to prevent undershoot and other DRAM problems. Such measures include inserting resistors in the RAS

and CAS lines and inserting capacitors between V<sub>SS</sub> pins. See the article on Designing with the Latest Microcontrollers and Memory in special issue number 25 of Transistor Technology for details on these measures. Since this device includes buffers that sink a current of 48 mA, applications must take adequate noise prevention measures.

#### **Block Diagram**



A12529

- \*1 WFCK, SBSO, SCOR
- \*2 BCK, SDATA, LRCK, C2PO
- \*3 DB0 to DB7, DBP, BSY, MSG, SEL, RST, REQ, I/O, C/D
- \*4 ACK, ATN
- \*5 RD, WR, SUA0 to SUA6, ZCS, CSCTRL
- \*6 D0 to D7
- \*7 IO0 to IO15
- \*8 RA0 to RA10,  $\overline{RAS1}$ ,  $\overline{CAS0}$ ,  $\overline{CAS1}$ ,  $\overline{OE}$ ,  $\overline{UWE}$ ,  $\overline{LWE}$
- \*9 DBCK, DLRCK, DSDATA
- \*10 IOP7 to IOP0

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